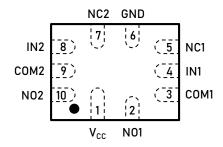
DESCRIPTION

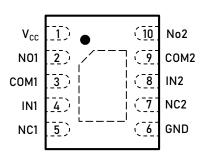
The LTC5223 is an advanced CMOS analog switch fabricated in Sub-micron silicon gate CMOS technology. The part also features guaranteed Break Before Make (BBM) switching, assuring the switches never short the driver.

FEATURES

- Ultra-Low Ron: 0.55 Ω Maximum at Vcc = 4.3 V
- Wide Supply Voltage Range: Single 1.65 V to 5.5 V
- Low Crosstalk
- Full 0 ~ Vcc Signal Handling Capability
- High Off Channel Isolation
- Low Standby Current: 50 nA Maximum
- Low Distortion
- RON Flatness: 0.15 Ω
- High Continuous Current Capability: ±300 mA Through Each Switch
- Suitable for Audio Block Switching, Ring-Tone Chips, Amplifier Switching, and Modems, etc.
- ESD: Human Body Model > 4 kV (Reference Document: MIL-STD-883H Method 3015.8)
- Available Packages: QFN1.8×1.4-10L, DFN3x3-10L, and MSOP-10L

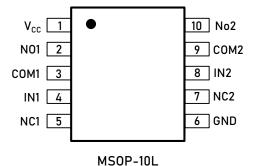
PIN CONFIGURATION (Top View)





QFN 1.8 X 1.4-10L

DFN 3 X 3-10L





ORDER INFORMATION

Model	Package	Ordering Number	Packing Option
LTC5223	QFN1.8×1.4-10L	LTC5223YFS10	Tape and Reel, 3 000
	DFN3×3-10L	LTC5223YF10	Tape and Reel, 3 000
	MSOP-10L	LTC5223YV10	Tape and Reel, 4 000

PIN DESCRIPTIONS

Pin	Symbol	Description
1	V _{cc}	Power Supply
2	N01	Independent Channels
3	COM1	Common Channels
4	IN1	Controls
5	NC1	Independent Channels
6	GND	Ground (V)
7	NC2	Independent Channels
8	IN2	Controls
9	COM2	Common Channels
10	N02	Independent Channels

TRUTH TABLE

IN1, IN2	N01, N02	NC1, NC2
0	OFF	ON
1	ON	OFF



RECOMMENDED OPERATING CONDITIONS

Characteristic		Symbol	Min	Max	Unit
DC Supply Voltag		V_{cc}	1.65	5.5	V
Digital Select Input Voltage		V _{IN}	GND	5.5	V
Analog Input Voltage		V _{IS}	GND	V _{cc}	V
Operating Temperature Range		T _A	-45	+85	°C
Input Rise or Fall Time	V _{CC} = 1.6 V to 2.7 V		0	20	A1
SELECT	V _{CC} = 3.0 V to 5.5 V	– t _R , t _F	0	10	ns/V

ABSOLUTE MAXIIMUM RATINGS

Characteristic	Symbol	Value	Unit
Supply Voltage	V_{cc}	-0.5 to 6.0	V
Analog Input Voltage	V_{IS}	-0.5 to V _{CC} + 0.5	٧
Digital Select Input Voltage	V_{IN}	-0.5 to 6.0	V
Output Voltage	V_{OUT}	-0.5 to V _{CC} + 0.5	V
Continuous DC Current from COM to NC/NO	lan1	±300	mA
Peak Current from COM to NC/NO, 10 duty cycle (Note 1)	lan1-pk1	±500	mA
Continuous DC Current into COM/NO/NC with respect to V _{CC} or GND	Iclmp	±100	mA

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note 1. Defined as 10% ON, 90% off duty cycle.

CAUTION

This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. Lineaein recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

Linearin reserves the right to make any change in circuit design, specification or other related things if necessary without notice at any time. Please contact Linearin sales office to get the latest data sheet.



ELECTRICAL CHARACTERISTICS (DC)

Symbol	Parameter	Test Conditions	V _{cc} ± 10%		T _A = 25°	C	T _A = - to +8		
5,500	r drameter	Took oomanions	100 = 1070	Min	Тур	Max	Min	Max	Unit
			1.65 ~ 1.95	1.1			1.1		
			2.3 ~ 2.5	1.2			1.2		•
V_{IH}	High-Level Input Voltage,		2.7 ~ 3.0	1.3			1.3		٧
	Select Inputs		3.0 ~ 3.6	1.4			1.4		•
			4.3	1.5			1.5		•
			1.65 ~ 1.95			0.25		0.25	
			2.3 ~ 2.5			0.25		0.25	
V_{IL}	Low-Level Input Voltage,		2.7 ~ 3.0			0.25		0.25	٧
	Select Inputs		3.0 ~ 3.6			0.30		0.30	•
			4.3			0.40		0.40	
I _{IN}	Maximum Input Leakage Current, Select Inputs	V _{IN} =V _{CC} or GND	4.3			±0.1		±1.0	μА
I _{OFF}	Power Off Leakage Current	V _{IN} =V _{CC} or GND	0			±0.5		±2.0	μA
I _{cc}	Maximum Quiescent Supply Current (Note 2)	Select, V _{IS} = V _{CC} or GND	1.65 ~ 4.3			±1.0		±2.0	μА
I _{NO (OFF)}	NC or NO Off Leakage Current	$V_{IN} = V_{IL} \text{ or } V_{IH}$ $V_{NO} \text{ or } V_{NC} = 0.3 \text{ V}$ $V_{COM} = 4.0 \text{ V}$	4.3	-5.0		5.0	-10	10	nA
	COM ON Leakage Current	(Note 3)							
I _{сом (ом)}	$V_{IN} = V_{IL}$ or V_{IH} , $V_{NO} = 0.3$ V or V_{NC} floating $V_{NC} = 0.3$ V or V_{NO} floating $V_{COM} = 0.3$ V or	or 4.0 V 4.0 V	4.3	-10		10	-100	100	nA
			4.3		0.45	0.5		0.55	
			3.6		0.5	0.55		0.65	•
Б	On-	V_{IS} = GND to V_{CC}	3.0		0.5	0.55		0.65	
R_{0N}	Resistance (Note 3)	I _{IN} = 100 mA	2.7		0.6	0.7		0.8	Ω
			2.3		0.6	0.7		8.0	
			1.8		0.9	1.0		1.1	
			4.3		0.15	0.20		0.20	
			3.6		0.15	0.20		0.20	
R_{FLAT}	On-Resistance Flatness	I _{COM} = 100 mA	3.0		0.15	0.20		0.20	Ω
T EAT	(Note 3) (Note 5)	V _{IS} = 1.5 V	2.7		0.15	0.20		0.20	-
			2.3		0.20	0.25		0.25	
			1.8		0.35	0.45		0.45	
ΔR_{0N}	On-Resistance Match Between Channels (Note 3) (Note 4)	I _{COM} = 100 mA V _{IS} = 1.5 V	2.7		0.1				Ω



ELECTRICAL CHARACTERISTICS (AC)

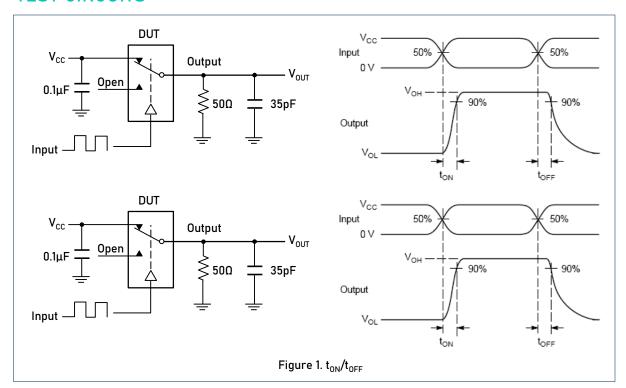
tPLH Propagation Delay	est Conditions (s = 0.8 V	V _{cc} ± 10% 1.65 ~ 1.95 2.3 ~ 2.7 3.0 ~ 3.3 3.6 ~ 5	Min	0.30 0.25	Max	Unit
tPHL Propagation Delay	_{IS} = 0.8 V	2.3 ~ 2.7 3.0 ~ 3.3 3.6 ~ 5		0.25		-
tPHL Propagation Delay	' _{IS} = 0.8 V	3.0 ~ 3.3 3.6 ~ 5				
Turn-On Time	_{IS} = 0.8 V	3.6 ~ 5		0.20		- ns
Turn-On Time	_{IS} = 0.8 V			0.20		
Turn-On Time	_{IS} = 0.8 V			0.20		
tON Turn-On Time		1.65 ~ 1.95		120		_
		2.3 ~ 2.7		65	85	ne ne
(Figure 1) V	_{IS} = 1.5 V	3.0 ~ 3.3		42	55	ns -
		3.6 ~ 4.3		40	55	
_ <u>V</u>	_{IS} = 0.8 V	1.65 ~ 1.95		45		_
tOFF Turn-Off Time		2.3 ~ 2.7		18	30	ns
(Figure 1)	_{IS} = 1.5 V	3.0 ~ 3.3		16	30	
(rigure 1)		3.6 ~ 4.3		15	30	
_		1.65 ~ 1.95	2	17		_
	C _L = 35 pF	2.3 ~ 2.7	2	10		
	R _{IS} = 50 Ω ' = 15 V	3.0 ~ 3.3	2	8		- ns -
v	V _{IS} = 1.5 V	3.6 ~ 4.3	2	7		
BW Response (Figure 4)				18		MHz
R _{IS} = 50 Ω						
Off-Channel Isolation (Figure						
V_{ISO} F_{IS} = 100 kHz, V_{IN} = GND to V_{CC} , R_L = 50 Ω , V_{IS} = 1 V_{RMS}	C _L = 5 pF	1.65 ~ 4.3		-66		dB
Charge Injection Select Input ((Figure 3)	to Common I/O	1.65 ~ 1.95		43		_
Q (Figure 5)		2.3 ~ 2.7		51		рC
$V_{IN} = 0 \text{ or } V_{CC}, R_{IS} = 0 \Omega, C_{L} = 10$	0 pF	3.0 ~ 3.3		51		_
$R_L = 1 \text{ m}\Omega$, $Q = C_L \times \Delta V_{OUT}$	•	3.6 ~ 4.3		49		
Total Harmonic Distortion THD) +Noise					
THD F_{IS} = 20 Hz to 20 kHz, R_L = 600 C_L = 50 pF V_{IS} = 2 VRMS	Ω	3.0		0.08		%
Channel - to - Channel Cross	talk (Figure 4)					
V_{CT} F_{IS} = 100 kHz, V_{IN} = GND to V_{CC} R_L = 50 Ω, C_L = 5 pF, V_{IS} = 1 VRM				-72		dB
CIN Control Pin Input Capacitance	Control Pin Input Capacitance			3.5		pF
C _{CN} /C _{NO} NC/NO Port Capacitance		3.6		60		pF
C _{COM} COM Port Capacitance When Switch is Enabled		3.6		200		pF

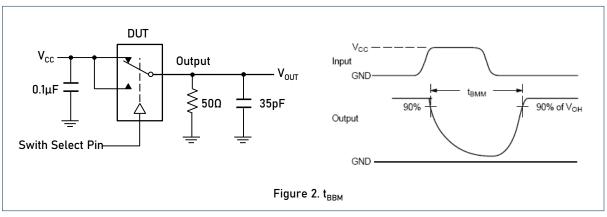
Note:

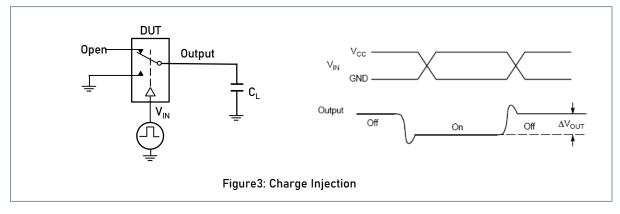
- 2. Guaranteed by design.
- 3. Guaranteed by design. Resistance measurements do not include test circuit or package resistance.
- 4. ΔR_{ON} = $R_{\text{ON (MAX)}}$ $R_{\text{ON (MIN)}}$ between NC1 and NC2 or between NO1 and NO2.
- 5. Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.
- 6. Guaranteed by design in -40°C.



TEST CIRCUITS

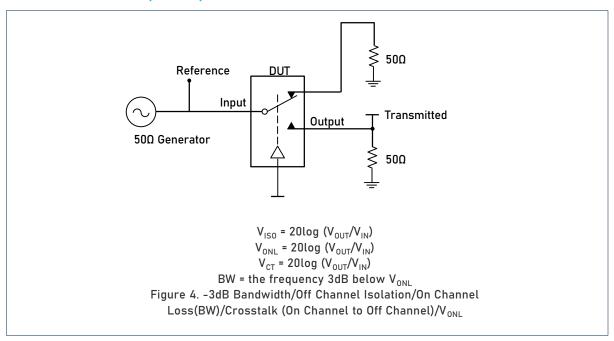




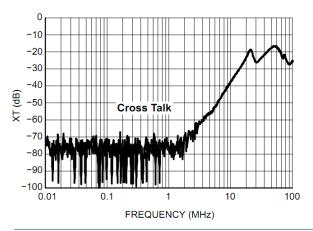


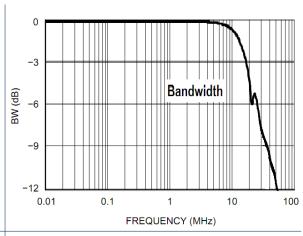


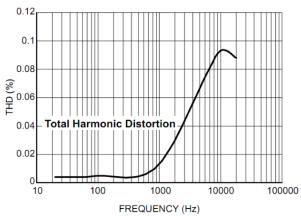
TEST CIRCUITS (Cont.)



TEST CIRCUITS (Cont.)



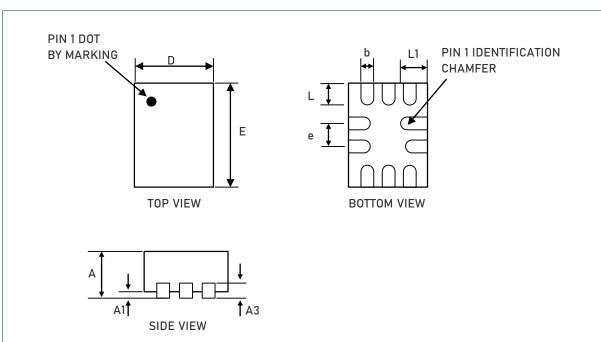






PACKAGE OUTLINE

QFN1.8×1.4-10L

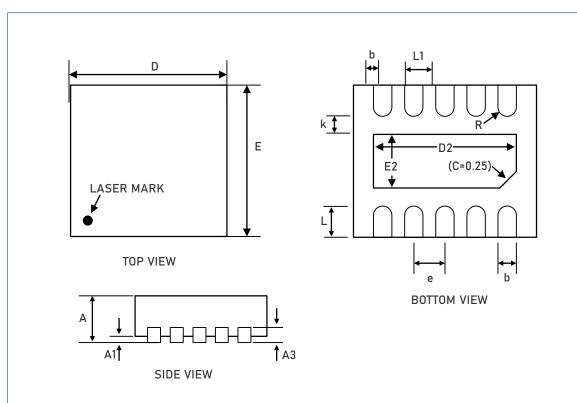


Dimensions In Millimeters (mm)				
Symbol	Min.	Nom.	Max.	
Α	0.500	0.550	0.600	
A1	0.000		0.050	
A3		0.15 REF		
D	1.350	1.400	1.450	
E	1.750	1.800	1.850	
b	0.150	0.200	0.250	
L	0.300	0.400	0.500	
L1	0.400	0.500	0.600	
е	0.40 BSC			



PACKAGE OUTLINE

DFN3×3-10L

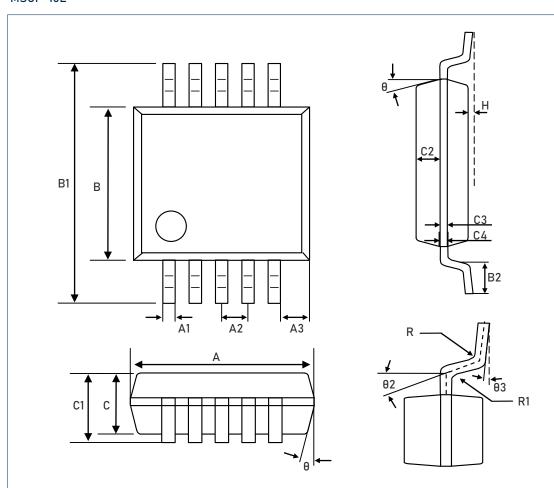


Cymhal	Dimensions	In Millimeters (mm)
Symbol	Min.	Max.
Α	0.700	0.800
A1	0.000	0.050
A3	0.203	BREF
b	0.180	0.300
D	2.900	3.100
D2	2.450	2.550
е	0.400	0.600
E	2.900	3.100
E2	1.450	1.650
L	0.350	0.450
k	0.150	
R	0.090	



PACKAGE OUTLINE

MSOP-10L



Cymbol	Dimensions In Millimeters (mm)			
Symbol	Min.	Max.		
Α	2.900	3.100		
A1	0.190	0.280		
A2	0.500 TYP			
A3	0.400 TYP			
В	2.900	3.100		
B1	4.700	5.100		
B2	0.450	0.750		
С	0.750 0.95			
C1	1.100			
C2	0.328 TYP			



单击下面可查看定价,库存,交付和生命周期等信息

>>Linearin(先积)